onsemi

Rectifier, High Efficiency, Glass Passivated, 1.0 A

EGP10B - EGP10K

Features

- Superfast Recovery Time for High Efficiency
- Low Forward Voltage, High Current Capability
- Low Leakage Current
- High Surge Current Capability

Symbol	Parameter	Value	Unit
Ι _Ο	Average Rectified Current 0.375" lead length @ T_L = 75°C	1.0	A
l _{f(surge)}	Peak Forward Surge Current 8.3 ms single half-sine-wave Superimposed on rated load (JEDEC method)	30	A
P _D	Total Device Dissipation Derate above 25°C	2.5 17	W mW°C
I _C	Thermal Resistance, Junction to Ambient	50	°C/W
Tj, Tstg	Junction and Storage Temperature Range	-65~150	°C

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

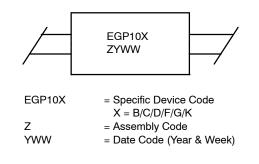
		Device						
Parameter		10B	10C	10D	10F	10G	10K	Unit
Peak Repetitive Reverse Voltage		100	150	200	300	400	800	V
Maximum RMS Voltage		70	105	140	210	280	560	V
DC Reverse Voltage (Rated V _R)		100	150	200	300	400	800	V
Maximum Reverse Current at Rated V _R	$T_A = 25^{\circ}C$	5.0					μΑ	
	$T_A = 125^{\circ}C$	100					μΑ	
Maximum Reverse Recovery Time $I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		50 75					nS	
Maximum Forward Voltage @ 2.0 A		0.95 1.25			1.7	V		
Typical Junction Capacitance $V_R = 4.0 V$, f = 1.0 MHz		22 15			•	pF		

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

*Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2%.



MARKING DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

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TYPICAL PERFORMANCE CHARACTERISTICS

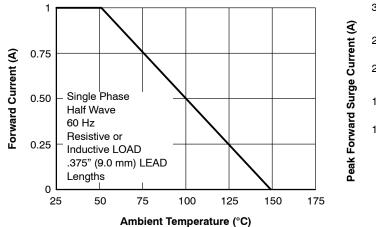


Figure 1. Forward Current Derating Curve

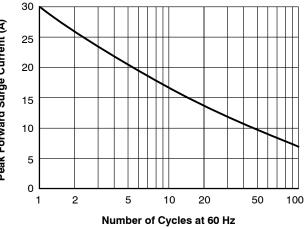


Figure 2. Non-Repetitive Surge Current

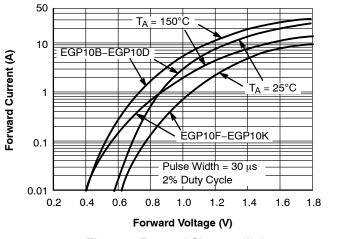


Figure 3. Forward Characteristics

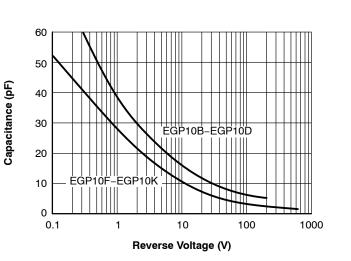


Figure 5. Junction Capacitance

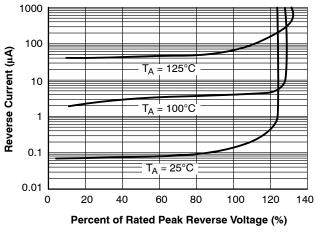
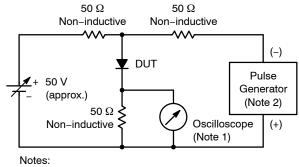


Figure 4. Reverse Characteristics

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Reverse Recovery Time Characteristic and Test Circuit Diagram



1. Rise time = 7.0 ns max; Input impedance = 1.0 M Ω 22 pF.

2. Rise time = 10 ns max; Source impedance = 50 Ω .



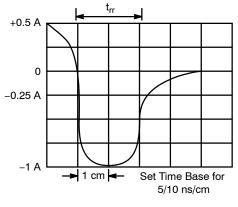


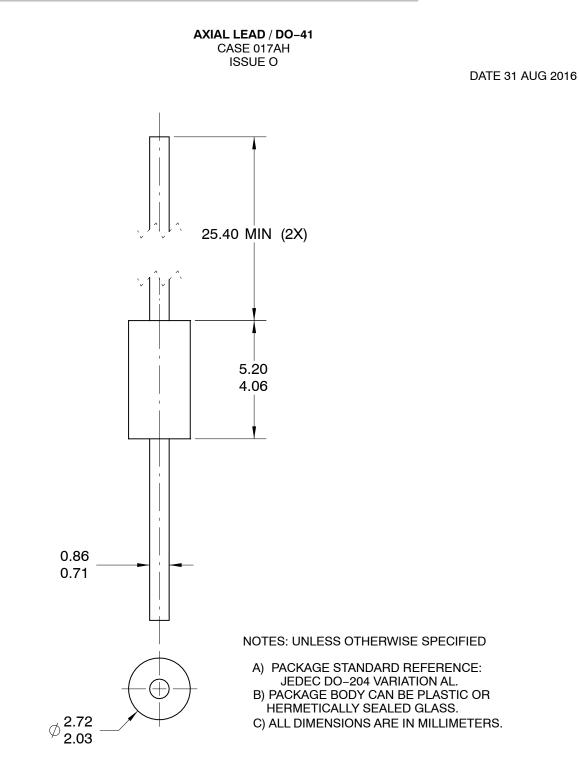
Figure 7. Reverse Recovery Time Characteristics

ORDERING INFORMATION

Device	Package	Shipping [†]
EGP10B	Axial Lead / DO-41	5000 / Tape & Reel
EGP10C	(Pb-Free)	
EGP10D		
EGP10F		
EGP10G		
EGP10K		

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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DESCRIPTION:	AXIAL LEAD / DO-41		PAGE 1 OF 1			
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